



BGRP201208-PCTC3

Multi-Wavelength SMD Type

Features

- Top view 0805 package
- Wide viewing angle
- BGR individual control
- High reliability
- RoHS compliance

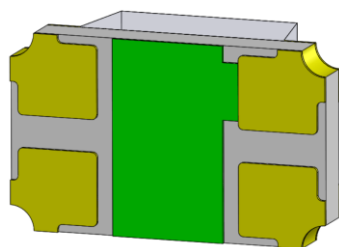
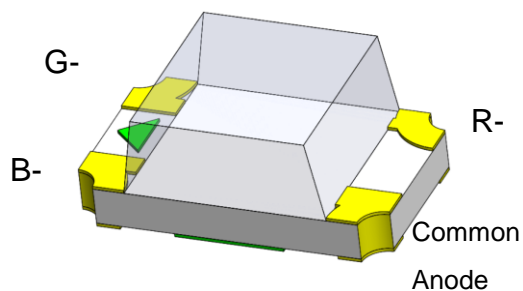
Applications

- Optical indicator.
- Switch and Symbol Display.

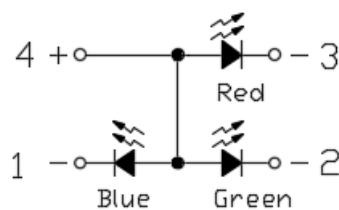
Description

The BGRP201208-PCTC3 is a high brightness device designed for demanding applications in efficiency and reduced space. An ideal device in emphasizing visual effects, advertisement, decoration as well as general backlighting needs.

Package Outline



Schematic





BGRP201208-PCTC3

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Absolute Maximum Rating at 25°C

| Symbol | Parameters | Ratings | | Units | Notes |
|------------------|--|------------|----|-------|-------|
| I _F | Continuous Forward Current | 25 | | mA | |
| I _{FP} | Peak Forward Current | 60 | | mA | 1 |
| V _R | Reverse Voltage | 5 | | V | |
| T _{opr} | Operating Temperature | -40 ~ +85 | | °C | |
| T _{stg} | Storage Temperature | -40 ~ +100 | | °C | |
| T _{sol} | Soldering Temperature | 260 | | °C | 2 |
| P _D | Power Dissipation at(or below) 25°C Free Air Temperature | B | 95 | mW | |
| | | G | 95 | | |
| | | R | 60 | | |

Electro-Optical Characteristics *TA = 25°C (unless otherwise specified)*

Optical Characteristics(Blue)

| Symbol | Parameters | Test Conditions | Min | Typ | Max | Units | Notes |
|------------------|-------------------------|---------------------|-----|-----|-----|-------|-------|
| I _v | Luminous Intensity | I _F =5mA | 36 | - | 90 | mcd | 3 |
| λ _D | Dominant Wavelength | I _F =5mA | 465 | - | 475 | nm | 4 |
| θ _{1/2} | Angle of Half Intensity | I _F =5mA | - | ±65 | - | deg | |

Electrical Characteristics

| Symbol | Parameters | Test Conditions | Min | Typ | Max | Units | Notes |
|----------------|-----------------|---------------------|-----|-----|-----|-------|-------|
| V _F | Forward Voltage | I _F =5mA | 2.4 | - | 3.1 | V | |
| I _R | Reverse Current | V _R =5V | - | - | 1 | μA | |



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Optical Characteristics(Green)

| Symbol | Parameters | Test Conditions | Min | Typ | Max | Units | Notes |
|------------------|-------------------------|---------------------|-----|-----|-----|-------|-------|
| I _V | Luminous Intensity | I _F =5mA | 180 | - | 450 | mcd | 3 |
| λ _D | Dominant Wavelength | I _F =5mA | 520 | - | 535 | nm | 4 |
| θ _{1/2} | Angle of Half Intensity | I _F =5mA | - | ±65 | - | deg | |

Electrical Characteristics

| Symbol | Parameters | Test Conditions | Min | Typ | Max | Units | Notes |
|----------------|-----------------|---------------------|-----|-----|-----|-------|-------|
| V _F | Forward Voltage | I _F =5mA | 2.3 | - | 3.0 | V | |
| I _R | Reverse Current | V _R =5V | - | - | 1 | μA | |

Optical Characteristics(Red)

| Symbol | Parameters | Test Conditions | Min | Typ | Max | Units | Notes |
|------------------|-------------------------|---------------------|------|-----|------|-------|-------|
| I _V | Luminous Intensity | I _F =5mA | 14.5 | - | 36.0 | mcd | 3 |
| λ _D | Dominant Wavelength | I _F =5mA | - | 633 | - | nm | |
| θ _{1/2} | Angle of Half Intensity | I _F =5mA | - | ±65 | - | deg | 4 |

Electrical Characteristics

| Symbol | Parameters | Test Conditions | Min | Typ | Max | Units | Notes |
|----------------|-----------------|---------------------|-----|-----|-----|-------|-------|
| V _F | Forward Voltage | I _F =5mA | 1.6 | - | 2.1 | V | |
| I _R | Reverse Current | V _R =5V | - | - | 1 | μA | |

Notes:

1. I_{FP} Conditions--Pulse Width ≤ 100μs and Duty ≤ 10%.
2. Soldering time ≤ 10 seconds.



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3. Bin Range of Luminous Intensity

| Blue | | | | |
|----------|------|------|------|---------------------|
| Bin Code | Min | Max | Unit | Condition |
| NA | 36 | 57 | mcd | I _F =5mA |
| PA | 57 | 90 | | |
| Green | | | | |
| S | 180 | 285 | mcd | I _F =5mA |
| T | 285 | 450 | | |
| Red | | | | |
| LA | 14.5 | 22.5 | mcd | I _F =5mA |
| MA | 22.5 | 36.0 | | |

Tolerance of: Luminous Intensity $\pm 10\%$

4. Bin Range of Dominant Wavelength(Blue)

| Bin Code | Min | Max | Unit | Condition |
|----------|-----|-----|------|---------------------|
| A6 | 465 | 470 | nm | I _F =5mA |
| A7 | 470 | 475 | | |

5. Bin Range of Dominant Wavelength(Green)

| Bin Code | Min | Max | Unit | Condition |
|----------|-----|-----|------|---------------------|
| A5 | 520 | 525 | nm | I _F =5mA |
| A6 | 525 | 530 | | |
| A7 | 530 | 535 | | |

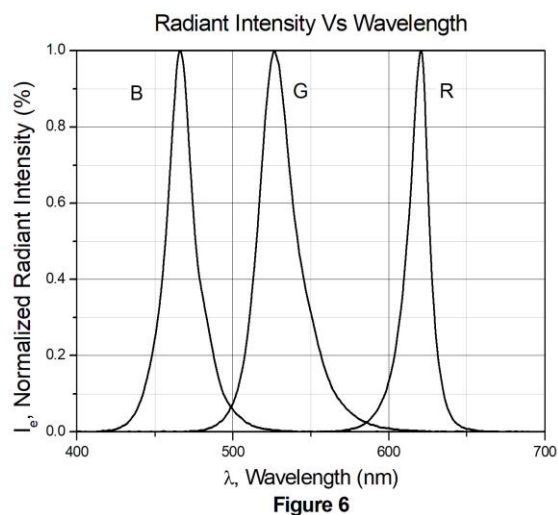
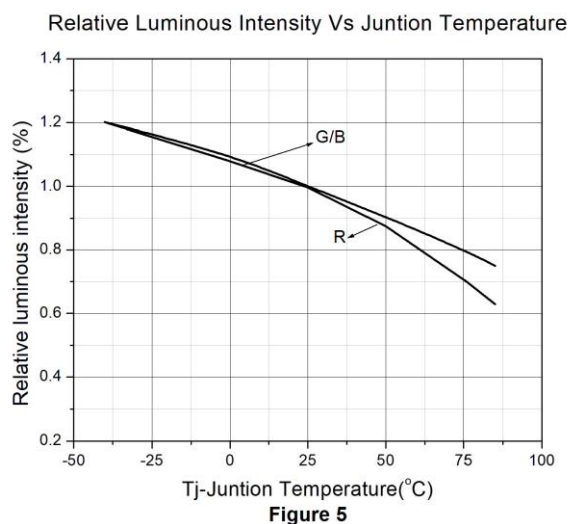
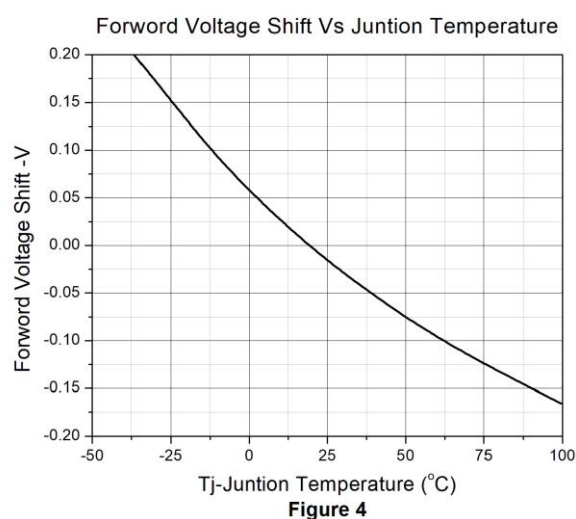
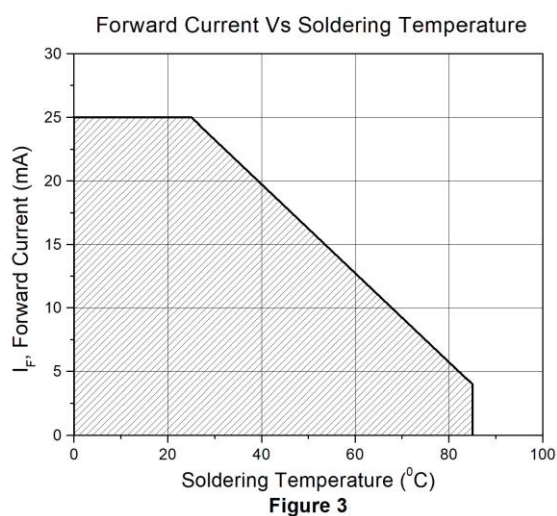
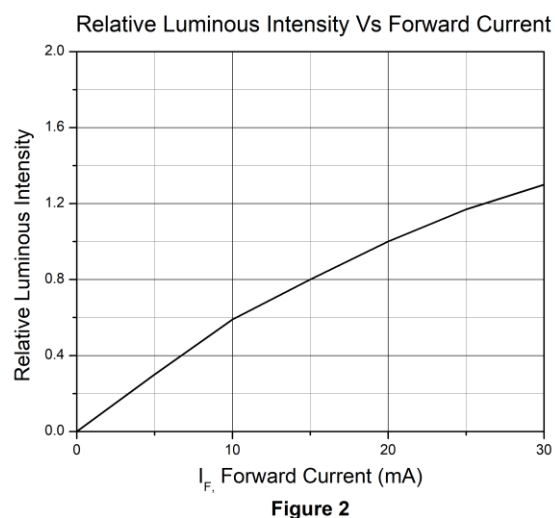
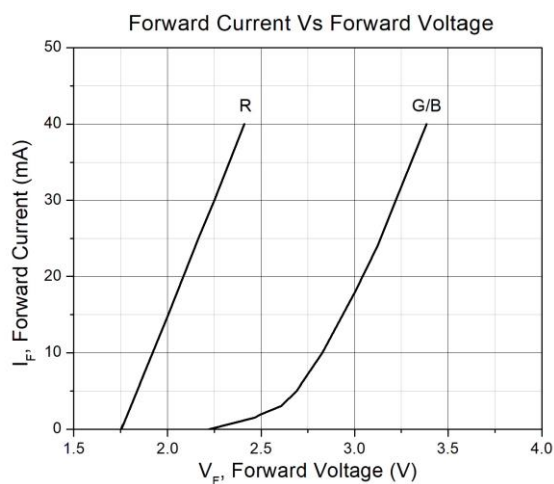
Tolerance of Dominant Wavelength: $\pm 1\text{nm}$.



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Multi-Wavelength SMD Type

Typical Characteristic Curves





Typical Characteristic Curves

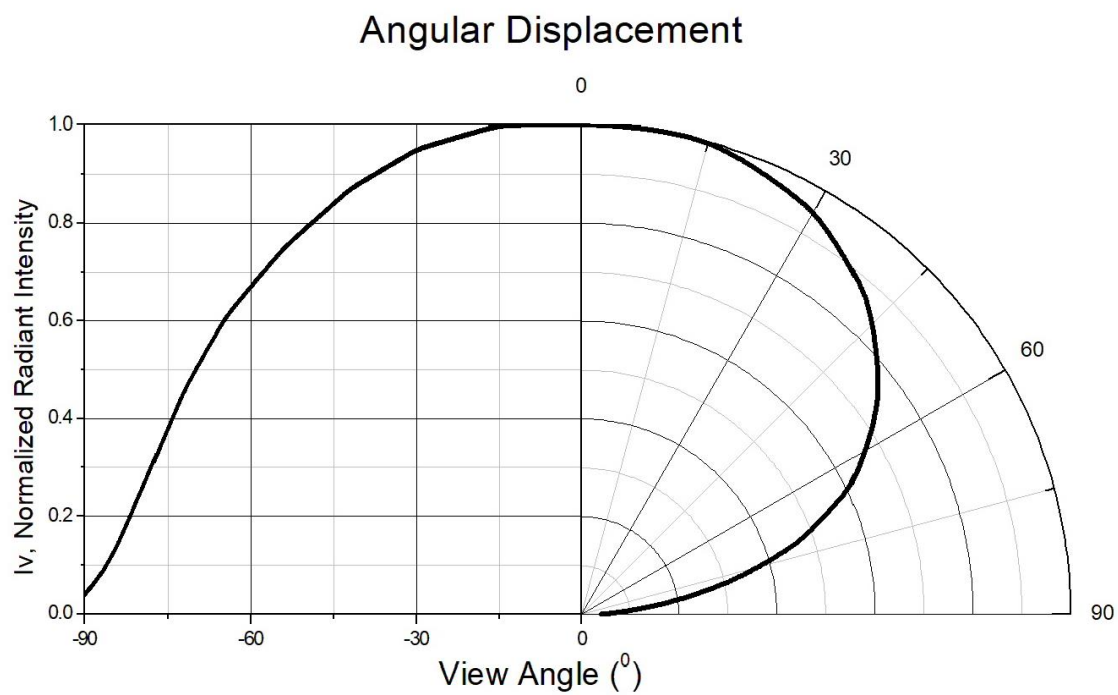


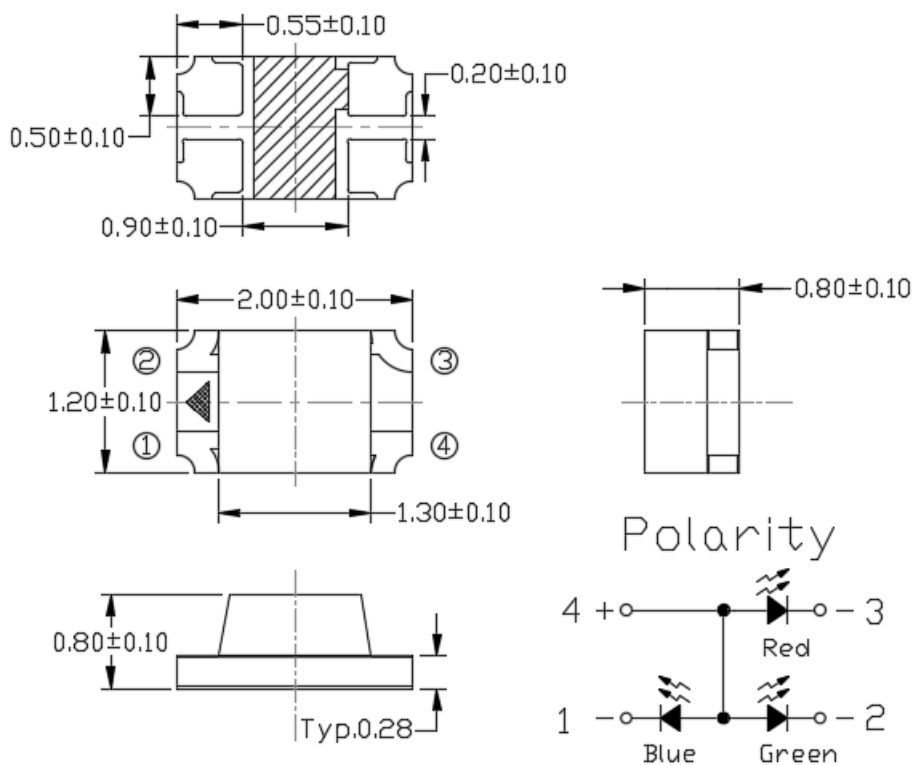
Figure 7



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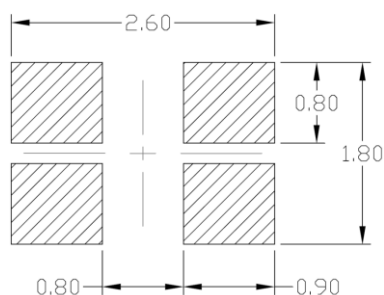
Multi-Wavelength SMD Type

Package Dimension *All dimensions are in mm, unless otherwise stated*



Note: Tolerance unless mentioned is ± 0.1 mm.

Recommended Soldering Mask *All dimensions are in mm, unless otherwise stated*



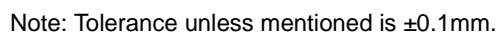
Note: Tolerance unless mentioned is ± 0.1 mm.

Ordering Information

| Part Number | Description | Quantity |
|------------------|-------------|----------|
| BGRP201208-PCTC3 | Tape & Reel | 3000 pcs |



Reel Dimension *All dimensions are in mm, unless otherwise stated*





BGRP201208-PCTC3

Multi-Wavelength SMD Type

Label Form Specification

CT Micro
International Corporation

MSL-X
MADE IN CHINA

CPN: XXXXXXXXXXXXXXXXX
|||||

Part no: XXXXXXXXXXXXXXX
|||||

Serial no: XXXXXXXX
|||||

Lot no: XXXXXXXX
|||||

Qty: XXXXXX Date Code: YWWJ
||||| |||||

IV: XX WD:XX VF:XX
||||| ||||| |||||

QR Code

Pb
RoHS

CPN : Customer Part Number
Part no: CTM Production Number
Serial no: Production Number
Lot no: Lot number
Q'ty: Packing Quantity
Date Code: Manufacture Date
IV : Bin Code of Luminous Intensity
WD : Bin Code of Dominant Wavelength
VF : Bin Code of Forward Voltage
MADE IN CHINA: Production Place

Storage Condition

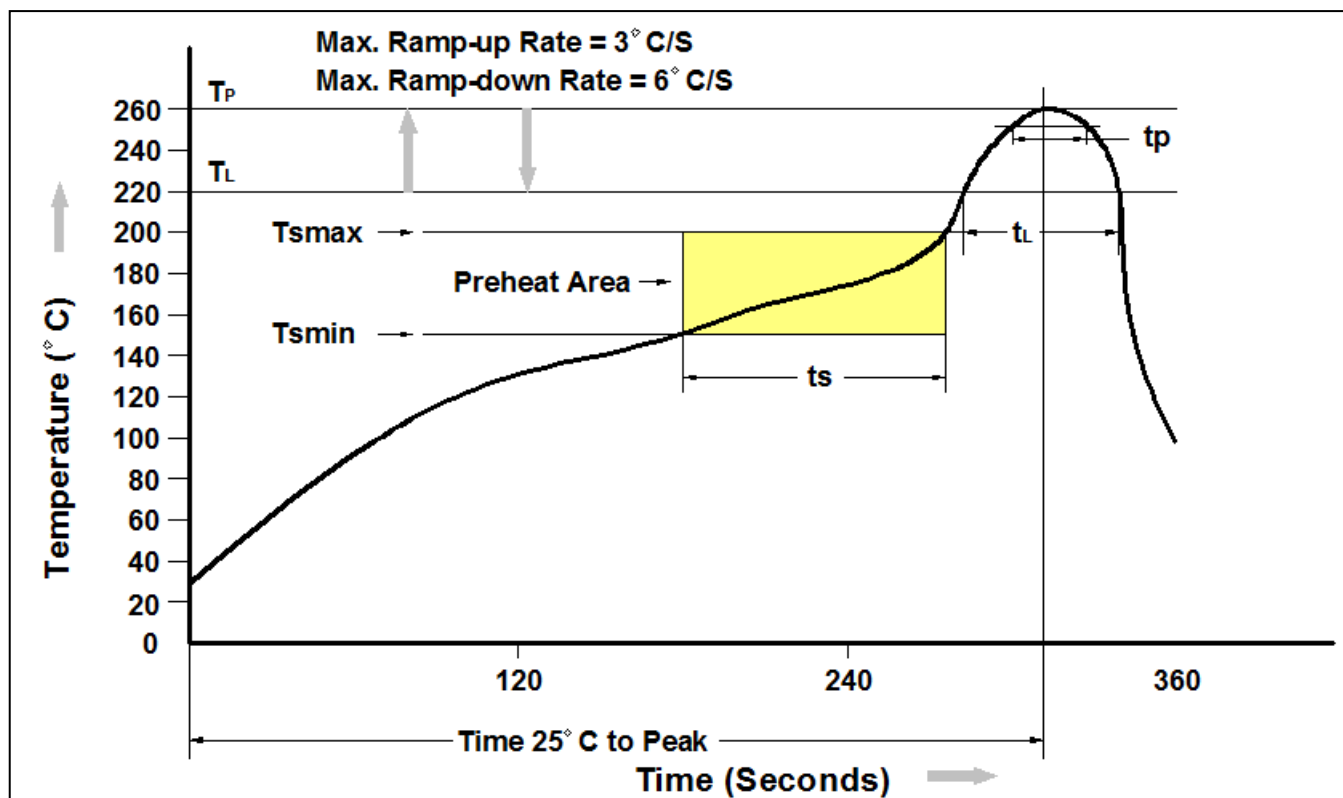
1. Do not open moisture proof bag before the products are ready to use.
2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening.
Shelf life of non-opened bag is 12 months after the bag sealing date.
3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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Reflow Profile



| Profile Feature | Pb-Free Assembly Profile |
|---------------------------------|--------------------------|
| Temperature Min. (Tsmin) | 150°C |
| Temperature Max. (Tsmax) | 200°C |
| Time (ts) from (Tsmin to Tsmax) | 60-120 seconds |
| Ramp-up Rate (tL to tP) | 3°C/second max. |
| Liquidous Temperature (TL) | 217°C |
| Time (tL) Maintained Above (TL) | 60 – 150 seconds |
| Peak Body Package Temperature | 260°C +0°C / -5°C |
| Time (tP) within 5°C of 260°C | 30 seconds |
| Ramp-down Rate (TP to TL) | 6°C/second max |
| Time 25°C to Peak Temperature | 8 minutes max. |



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